

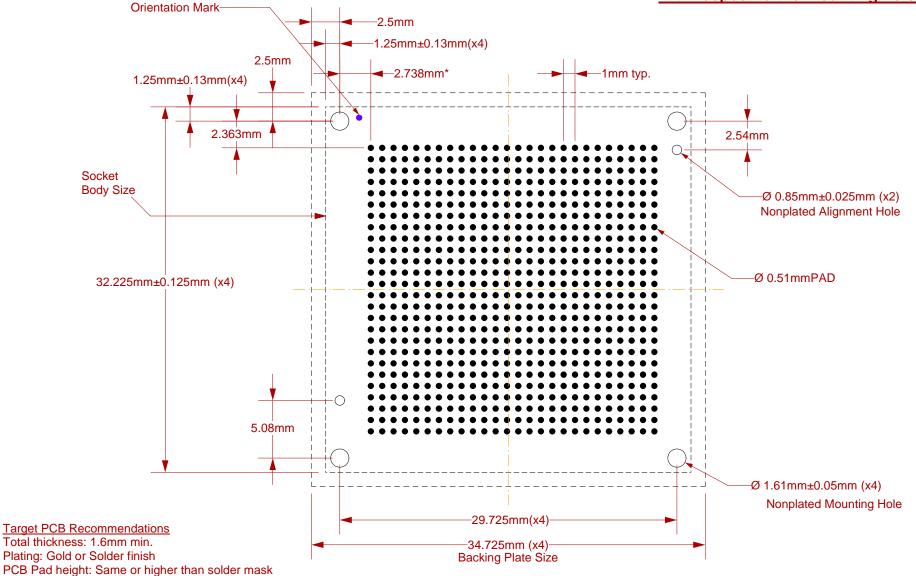
SG-BGA-6009 Drawing	Status: Released	Scale: -		Rev: H	All tolerand otherwise)
© 2001 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121	Drawing: Meghann Fedde		Date: 8/17	7/01	are subject
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All tolerances:  $\pm 0.125$ mm (unless stated otherwise). Materials and specifications are subject to change without notice.

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Recommended PCB Layout Top View

## \*Note: BGA pattern is not symmetrical with respect to the mounting holes.

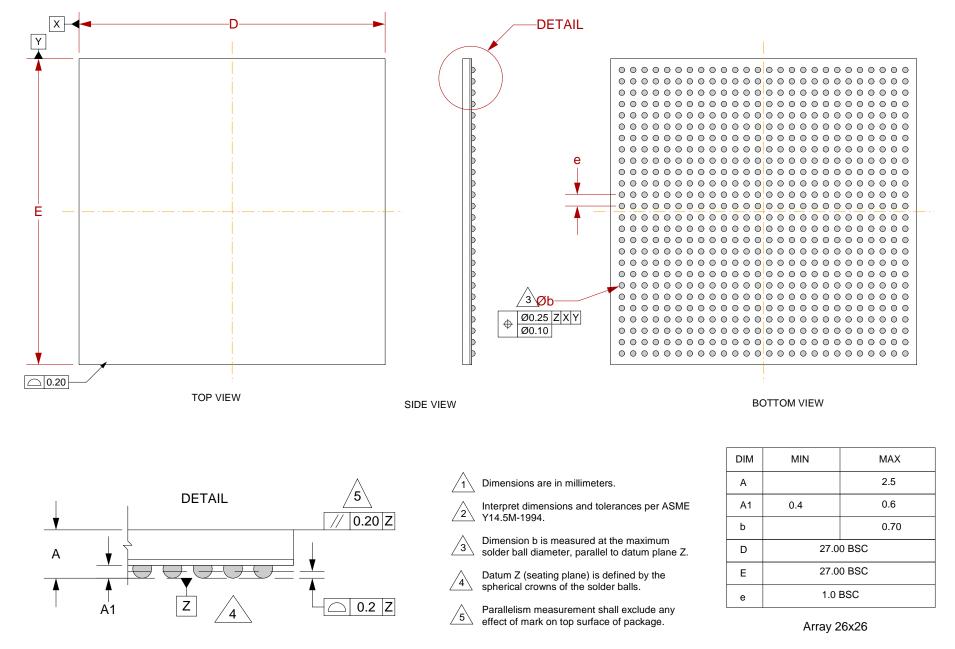


NOTE: Steel backing plate may be required based on end user's application

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.

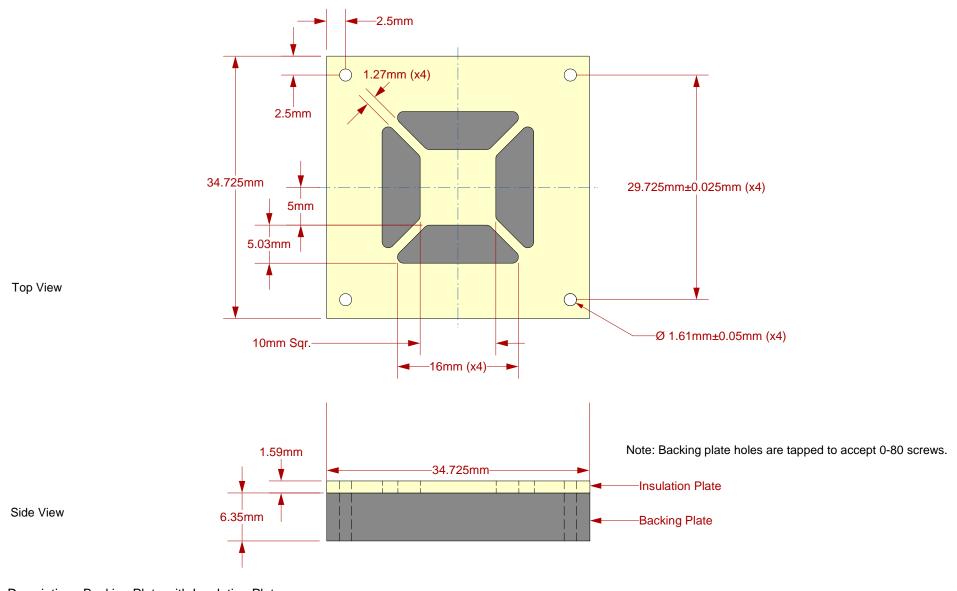
	SG-BGA-6009 Drawing	Status: Released	Scale: 3:1		Rev: H	
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## Description: Backing Plate with Insulation Plate

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All dimensions are in mm. All tolerences are +/- 0.125mm. (Unless stated otherwise)